								]				
<b>PCN Number:</b> 20170405000					PCN Date: Ap			Apr	oril 24, 2017			
Title: Datasheet for LM98714												
Customer Contact: PCN Manager					Dept:			Quality Services				
Proposed 1 <sup>st</sup> Ship Da	4, 2017											
Change Type:												
Assembly Site	Design								Wafe	/afer Bump Site		
Assembly Process				🔀 Data Sheet					Wafer Bump Material			
Assembly Materials				Part number change				_	Wafer Bump Process			
Mechanical Specification				Test Site				-	Wafer Fab Site Wafer Fab Materials			
Packing/Shipping/Labeling				Test Process				=				5
					Wafer Fab Process							
Notification Details												
Description of Chang		tod io a			inform	ation o	-	+:	ficat	ian		
Texas Instruments Inco The product datasheet(								loti	ricat	lon.		
	5) 15 1	Jeing u	puc	iteu as sui	manze	u belo	vv.					
The CMOS Clock Input	electr	ical cha	arad	teristics in	the dat	asheet	t are	cha	anair	na from	n:	
LVDS/CMOS Clock R										.9	••	]
Symbol Parameter			per		Condit		Min		тур	Max	Units	-
					Conuic	10115	1.1111	1	ур			-
	Clock Input High									280	μA	-
IILC CMOS Clock Input Low Current			rent						-150	μA	J	
To:												
				<b>C</b> : L' ()								1
	LVDS/CMOS Clock Receiver DC Specifications (			incations (								-
Symbol Parameter					Condit	ions	Min		ур	Max	Units	-
	< Inpu	put High Current								330	μA	-
IILC CMOS Clock Input Low Current			rent						-160	μA		
In addition, the following administrative updates to the datasheet format were made.												
Additional changes from	n Revi	ision A	(]a	nuary 201	4) to Re	vision	В					
								e, Fe	eatu	re Desc	cription a	section,
- Added Pin Configuration and Functions section, ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply												
Recommendations section, Layout section, Device and Documentation Support section, and												
Mechanical, Packaging, and Orderable Information section.												
The datasheet number will be changing.												
Device Family			Change From:						Change To:			
LM98714			SNAS254A						SNAS254B			
These changes may be reviewed at the datasheet links provided.												
http://www.ti.com/product/LM98714												
Reason for Change:												
To more accurately reflect device characteristics.												
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):												
Electrical specification	perfor	mance	cha	anges as in	dicated	above						
Changes to product identification resulting from this PCN:												
None.												

Product Affected:			
LM98714BCMT/NOPB	LM98714BCMTX/NOPB	LM98714CCMT/NOPB	LM98714CCMTX
LM98714CCMTX/NOPB			

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com